

Programmable TCH™ for Differential PIII™ Processor

Recommended Application:

VIA PL133-T style chipset with Intel differential PIII processor

Output Features:

- 2 CPUs @2.5V
- 13 SDRAM @ 3.3V
- 7 PCI @3.3V.
- 1 48MHz, @3.3V
- 1 24MHz @ 3.3V
- 2 REF @3.3V, 14.318MHz.

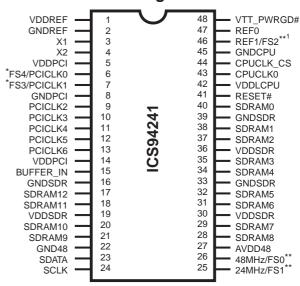
Features:

- Programmable ouput frequency
- · Programmable ouput rise/fall time
- · Programmable output to output skew
- Programmable spread spectrum for EMI control
- Real time system reset output
- Watchdog timer technology to reset system if over-clocking causes malfunction
- Uses external 14.318MHz crystal

Key Specifications:

- CPU CPU: <175ps
- SDRAM SDRAM: <500ps
- PCI PCI: <500psCPU-SDRAM: <500ps
- CPU(early)-PCI: Min=1.0ns, Typ=2.0ns, Max=4.0ns

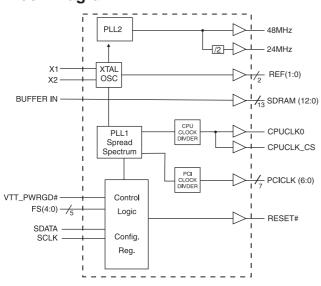
Pin Configuration



48-Pin 300mil SSOP

- * Internal Pull-up Resistor of 120K to VDD
- ** Internal Pull-down resistor of 120K to GND
- 1. This output has 1.5 to 2X drive strength

Block Diagram



Functionality

Bit2 FS4	Bit7 FS3	Bit6 FS2	Bit5 FS1	Bit4 FS0	CPUCLK	PCICLK	Spread Percentage
0	0	0	0	0	66.67	33.33	+/- 0.25 Center Spread
0	0	0	0	1	66.67	33.33	0 to -0.5% Down Spread
0	0	0	1	0	68.67	34.33	± 0.25 Center Spread
0	0	0	1	1	71.34	35.66	+/- 0.25 Center Spread
0	1	0	0	0	100.00	33.33	+/- 0.25 Center Spread
0	1	0	0	1	100.00	33.33	0 to -0.5% Down Spread
0	1	0	1	0	103.00	34.33	+/- 0.25 Center Spread
0	1	0	1	1	107.00	35.67	+/- 0.25 Center Spread
1	0	0	0	0	200.00	33.33	+/- 0.25 Center Spread
1	0	0	0	1	200.00	33.33	0 to -0.5% Down Spread
1	0	0	1	0	206.00	34.33	+/- 0.25 Center Spread
1	0	0	1	1	214.00	35.67	+/- 0.25 Center Spread
1	1	0	0	0	133.33	33.33	+/- 0.25 Center Spread
1	1	0	0	1	133.33	33.33	0 to -0.5% Down Spread
1	1	0	1	0	137.33	34.33	+/- 0.25 Center Spread
1	1	0	1	1	142.67	35.67	+/- 0.25 Center Spread

For additional margin testing frequencies refer to pg 5 frequency table.



General Description

The ICS94241 is a single chip timing control hub for desktop designs using VIA PL133-T style chipset with Intel differential PIII processor. It provides all necessary clock signals for such a system.

The ICS94241 is part of a whole new line of ICS clock generators and buffers called TCH™ (Timing Control Hub). ICS is the first to introduce a whole product line which offers full programmability and flexibility on a single clock device. This part incorporates ICS's newest clock technology which more robust features and functionality. Employing the use of a serially programmable I²C interface, this device can adjust the output clocks by configuring the frequency setting, the output divider ratios, selecting the ideal spread percentage, the output skew, the output strength, and enabling/disabling each individual output clock. TCH also incorporates ICS's Watchdog Timer technology in having a frequency reset feature to provide a safe setting under unstable system conditions.

Pin Configuration

PIN NUMBER	PIN NAME	TYPE	DESCRIPTION
1, 5, 14, 19, 30, 36	VDD	PWR	Power supply, nominal 3.3V
2, 8, 16, 22, 33, 39, 45	GND	PWR	Ground
3	X1	IN	Crystal input, has internal load cap (36pF) and feedback resistor from X2
4	X2	OUT	Crystal output, nominally 14.318MHz. Has internal load cap (36pF)
	FS4 ^{1,3}	IN	Frequency select pin. Latched Input. Internal Pull-down to GND
6	PCICLK0	OUT	PCI clock outputs. Synchronous to CPU clocks with 1-4ns skew (CPU early)
	FS3 ^{1,3}	IN	Frequency select pin. Latched Input. Internal Pull-down to GND
7	PCICLK1	OUT	PCI clock outputs. Synchronous to CPU clocks with 1-4ns skew (CPU early)
13, 12, 11, 10, 9	PCICLK (6:2)	OUT	PCI clock outputs. Synchronous to CPU clocks with 1-4ns skew (CPU early)
15	BUFFER IN	IN	Input to Fanout Buffers for SDRAM outputs.
17, 18, 20, 21, 28, 29, 31, 32, 34, 34, 35, 37, 38, 40	SDRAM (12:0)	OUT	SDRAM clock outputs, Fanout Buffer outputs from BUFFER IN pin (controlled by chipset)
23	SDATA	I/O	Data pin for I ² C circuitry 5V tolerant
24	SCLK	IN	Clock pin of I ² C circuitry 5V tolerant
0.5	FS1 ^{2,3}	IN	Frequency select pin. Latched Input.
25	24MHz	OUT	24MHz output clock
00	48MHz	OUT	48MHz output clock
26	FS0 ^{2,3}	IN	Frequency select pin. Latched Input
27	AVDD48	PWR	Analog power for 48MHz outputs
41	RESET	OUT	Real time system reset signal for frequency ratio change or watchdog timmer timeout. This signal is active low.
42	VDDLCPU	PWR	Supply for CPU clocks 2.5V nominal
43	CPUCLK0	OUT	CPU clock outputs
44	CPUCLK_CS	OUT	CPU clock output for chipset host clock
46	FS2 ^{2,3}	IN	Frequency select pin. Latched Input
40	REF1	OUT	14.318 MHz reference clock.
47	REF0	OUT	14.318 Mhz reference clock.
48	VTT_PWRGD#	IN	This 3.3V LVTTL input is a level sensitive strobe used to determine when FS inputs are valid and are ready to be sampled (active low)

Notes:

- 1: Internal Pull-up Resistor of 120K to 3.3V on indicated inputs
- 2: Internal Pull-down to GND on indicated inputs
- 3: Bidirectional input/output pins, input logic levels are latched at internal power-on-reset. Use 10Kohm resistor to program logic Hi to VDD or GND for logic low.

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General I²C serial interface information for the ICS94241

How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address D2_(H)
- ICS clock will acknowledge
- Controller (host) sends a dummy command code
- ICS clock will acknowledge
- Controller (host) sends a dummy byte count
- ICS clock will acknowledge
- Controller (host) starts sending *Byte 0 through Byte 20* (see Note)
- ICS clock will acknowledge each byte one at a time
- Controller (host) sends a Stop bit

How to Write: Controller (Host)	eceiver)
Start Bit	eceivei)
Address D2 _(H) Dummy Command Code Dummy Byte Count Byte 0 ACK Byte 1 ACK Byte 2 ACK Byte 3 ACK Byte 4 ACK ACK ACK ACK ACK ACK ACK AC	
ACK	
Dummy Command Code	
ACK Dummy Byte Count ACK Byte 0 ACK Byte 1 ACK Byte 2 ACK Byte 3 ACK Byte 4 ACK ACK	
Dummy Byte Count	
Byte 0 ACK Byte 1 ACK Byte 1 ACK Byte 2 ACK Byte 3 ACK Byte 4 ACK ACK ACK ACK ACK ACK ACK AC	
Byte 0 ACK Byte 1 ACK Byte 2 ACK Byte 3 ACK Byte 4 ACK	
Byte 1 Byte 2 ACK Byte 2 ACK Byte 3 ACK Byte 4 ACK	
Byte 1 Byte 2 ACK Byte 2 ACK Byte 3 ACK Byte 4 ACK	
Byte 1 ACK Byte 2 ACK Byte 3 ACK Byte 4 ACK	
Byte 2 ACK Byte 3 ACK Byte 4 ACK ACK	
Byte 2 ACK Byte 3 ACK Byte 4 ACK	
Byte 3 ACK Byte 4 ACK	
Byte 3 ACK Byte 4 ACK	
Byte 4 ACK ACK	
Byte 4	
ACK	
Byte 5	
ACK	
Byte 6	
ACK	
0 0	
0 0	
0 0	
0	
Byte 18	
ACK	
Byte 19	
ACK	
Byte 20	
ACK	
Stop Bit	

^{*}See notes on the following page.

How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the read address D3 (H)
- ICS clock will acknowledge
- ICS clock will send the byte count
- Controller (host) acknowledges
- ICS clock sends Byte 0 through byte 8 (default)
- ICS clock sends Byte 0 through byte X (if $X_{(H)}$ was written to byte 8).
- · Controller (host) will need to acknowledge each byte
- Controller (host) will send a stop bit

How to R	ead:
Controller (Host)	ICS (Slave/Receiver)
Start Bit	,
Address D3 _(H)	
	ACK
	Byte Count
ACK	
	Byte 0
ACK	
1014	Byte 1
ACK	D-4- 0
ACK	Byte 2
ACK	Byte 3
ACK	Dyte 5
, non	Byte 4
ACK	
	Byte 5
ACK	
	Byte 6
ACK	
If 7 _H has been written to B6	Byte 7
ACK	
0	0
0	0
0	0
W.40	D 4:40
If 12 _H has been written to B6	Byte18
ACK	
If 13 _H has been written to B6	Byte 19
ACK	
If 14 _H has been written to B6	Byte 20
ACK	
Stop Bit	



Brief I²C registers description for ICS94241 Programmable System Frequency Generator

Register Name	Byte	Description	PWD Default
Functionality & Frequency Select Register	0	Output frequency, hardware / I ² C frequency select, spread spectrum & output enable control register.	See individual byte description
Output Control Registers	1-6	Active / inactive output control registers/latch inputs read back.	See individual byte description
Vendor ID & Revision ID Registers	7	Byte 7 bit (7:4) is ICS vendor id - 001. Other bits in this register designate device revision ID of this part.	See individual byte description
Byte Count Read Back Register	8	Writing to this register will configure byte count and how many byte will be read back. Do not write 00 _H to this bute	08 _H
Watchdog Timer Count Register	9	Writing to this register will configure the number of seconds for the watchdog timer to reset.	10 _H
Watchdog Control Registers	10 Bit [6:0]	Watchdog enable, watchdog status and programmable 'safe' frequency' can be configured in this register.	000,000
VCO Control Selection Bit	10 Bit [7]	This bit select whether the output frequency is control by hardware/byte 0 configurations or byte 11&12 programming.	0
VCO Frequency Control Registers	11-12	These registers control the dividers ratio into the phase detector and thus control the VCO output frequency.	Depended on hardware/byte 0 configuration
Spread Spectrum Control Registers	13-14	These registers control the spread percentage amount.	Depended on hardware/byte 0 configuration
Group Skews Control Registers	15-16	Increment or decrement the group skew amount as compared to the initial skew.	See individual byte description
Output Rise/Fall Time Select Registers	17-20	These registers will control the output rise and fall time.	See individual byte description

Notes:

- 1. The ICS clock generator is a slave/receiver, I²C component. It can read back the data stored in the latches for verification. Readback will support standard SMBUS controller protocol. **The number of bytes to readback is defined by writing to byte 8.**
- 2. **When writing to byte 11 12, and byte 13 14, they must be written as a set.** If for example, only byte 14 is written but not 15, neither byte 14 or 15 will load into the receiver.
- 3. The data transfer rate supported by this clock generator is 100K bits/sec or less (standard mode)
- 4. The input is operating at 3.3V logic levels.
- 5. The data byte format is 8 bit bytes.
- 6. To simplify the clock generator I²C interface, the protocol is set to use only Block-Writes from the controller. The bytes must be accessed in sequential order from lowest to highest byte with the ability to stop after any complete byte has been transferred. The Command code and Byte count shown above must be sent, but the data is ignored for those two bytes. The data is loaded until a Stop sequence is issued.
- 7. At power-on, all registers are set to a default condition, as shown.

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Byte 0: Functionality and frequency select register (Default=0)

Bit	Description PWD								
	Bit2	Bit7	Bit6	Bit5	Bit4	CPUCLK	DCICL K	Careed Develope	
	FS4	FS3	FS2	FS1	FS0	CPUCLK	PCICLK	Spread Percentage	
	0	0	0	0	0	66.67	33.33	Center Spread +/- 0.25%	
	0	0	0	0	1	66.67	33.33	Down Spread 0 to - 0.5%	
	0	0	0	1	0	68.67	34.33	Center Spread +/- 0.25%	
	0	0	0	1	1	71.34	35.66	Center Spread +/- 0.25%	
	0	0	1	0	0	73.34	36.66	Center Spread +/- 0.25%	
	0	0	1	0	1	76.67	38.33	Center Spread +/- 0.25%	
	0	0	1	1	0	150.00	30.00	Center Spread +/- 0.25%	
	0	0	1	1	1	166.67	33.33	Center Spread +/- 0.25%	
	0	1	0	0	0	100.00	33.33	Center Spread +/- 0.25%	
	0	1	0	0	1	100.00	33.33	Down Spread 0 to - 0.5%	
	0	1	0	1	0	103.00	34.33	Center Spread +/- 0.25%	
	0	1	0	1	1	107.00	35.67	Center Spread +/- 0.25%	
	0	1	1	0	0	110.00	36.67	Center Spread +/- 0.25%	
	0	1	1	0	1	115.00	38.33	Center Spread +/- 0.25%	
Bit	0	1	1	1	0	100.90	33.63	Center Spread +/- 0.25%	Note 1
2, (7:4)	0	1	1	1	1	90.00	30.00	Center Spread +/- 0.25%	NOIE I
	1	0	0	0	0	200.00	33.33	Center Spread +/- 0.25%	
	1	0	0	0	1	200.00	33.33	Down Spread 0 to - 0.5%	
	1	0	0	1	0	206.00	34.33	Center Spread +/- 0.25%	
	1	0	0	1	1	214.00	35.67	Center Spread +/- 0.25%	
	1	0	1	0	0	220.00	36.67	Center Spread +/- 0.25%	
	1	0	1	0	1	230.00	38.33	Center Spread +/- 0.25%	
	1	0	1	1	0	201.80	33.63	Center Spread +/- 0.25%	
	1	0	1	1	1	180.00	30.00	Center Spread +/- 0.25%	
	1	1	0	0	0	133.33	33.33	Center Spread +/- 0.25%	
	1	1	0	0	1	133.33	33.33	Down Spread 0 to - 0.5%	
	1	1	0	1	0	137.33	34.33	Center Spread +/- 0.25%	
	1	1	0	1	1	142.67	35.67	Center Spread +/- 0.25%	
	1	1	1	0	0	146.67	36.67	Center Spread +/- 0.25%	
	1	1	1	0	1	153.33	38.33	Center Spread +/- 0.25%	
	1	1	1	1	0	133.90	33.48	Center Spread +/- 0.25%	
	1 1 1 1 120.00 30.00 Center Spread +/- 0.25%								
Bit 3	0=Fr	eque	ncy se	electe	d by	hardware;	1=Freque	ncy selected by Bit2, (7:4)	0
Bit 1	0=S	oread	off; 1	=Spr	ead S	pectrum E	nable		1
Bit 0	0=R	unnin	g; 1=1	Frista	te				0

Notes:

1. Default at power-up will be for latched logic inputs to define frequency, as displayed by Bit 3.



Byte 1: CPU, Active/Inactive Register (1= enable, 0 = disable)

BIT	PIN#	PWD	DESCRIPTION
Bit 7	-	X	Latched FS2#
Bit 6	-	1	(Reserved)
Bit 5	-	1	(Reserved)
Bit 4	-	1	(Reserved)
Bit 3	40	1	SDRAM0
Bit 2	-	1	(Reserved)
Bit 1	43	1	CPUCLK0
Bit 0	44	1	CPUCLK_CS

Byte 2: PCI, Active/Inactive Register (1= enable, 0 = disable)

BIT	PIN#	PWD	DESCRIPTION
Bit 7	-	1	(Reserved)
Bit 6	6	1	PCICLK0
Bit 5	13	1	PCICLK6
Bit 4	12	1	PCICLK5
Bit 3	11	1	PCICLK4
Bit 2	10	1	PCICLK3
Bit 1	9	1	PCICLK2
Bit 0	7	1	PCICLK1

Byte 3: SDRAM, Active/Inactive Register (1= enable, 0 = disable)

BIT	PIN#	PWD	DESCRIPTION
Bit 7	-	1	(Reserved)
Bit 6	-	X	Latched FS0#
Bit 5	26	1	48MHz
Bit 4	25	1	24 MHz
Bit 3	-	1	(Reserved)
Bit 2	17, 18, 20, 21	1	SDRAM (12:9)
Bit 1	28, 29, 31, 32	1	SDRAM (8:5)
Bit 0	34, 35, 37, 38	1	SDRAM (4:1)
Bit 0		1	SDRAM (4:1)

Byte 4: Reserved , Active/Inactive Register (1= enable, 0 = disable)

BIT	PIN#	PWD	DESCRIPTION
Bit 7	-	1	(Reserved)
Bit 6	-	1	(Reserved)
Bit 5	-	1	(Reserved)
Bit 4	-	1	(Reserved)
Bit 3	-	X	Latched FS1#
Bit 2	-	X	Latched FS4#
Bit 1	_	X	Latched FS3#
Bit 0	-	1	(Reserved)

Byte 5: Peripheral , Active/Inactive Register (1= enable, 0 = disable)

BIT	PIN#	PWD	DESCRIPTION
Bit 7	-	1	(Reserved)
Bit 6	-	1	(Reserved)
Bit 5	-	1	(Reserved)
Bit 4	-	1	(Reserved)
Bit 3	-	1	(Reserved)
Bit 2	-	1	(Reserved)
Bit 1	46	1	REF1
Bit 0	47	1	REF0

Byte 6: Peripheral , Active/Inactive Register (1= enable, 0 = disable)

BIT | PIN# | PWD | DESCRIPTION

BIT	PIN#	PWD	DESCRIPTION
Bit7	-	0	Reserved (Note)
Bit6	-	1	Reserved (Note)
Bit5	-	X	Reserved (Note)
Bit4	-	X	Reserved (Note)
Bit3	-	X	Reserved (Note)
Bit2	-	X	Reserved (Note)
Bit1	-	X	Reserved (Note)
Bit0	-	X	Reserved (Note)

Note: This is an unused register writing to this register will not affect device performance or functinality.

Notes:

Inactive means outputs are held LOW and are disabled from switching.

^{2.} Latched Frequency Selects (FS#) will be inverted logic outsigned by the input frequency select pin conditions.



Byte 7: Vendor ID and Revision ID Register

Bit	PWD	Description
Bit 7	0	Vendor ID
Bit 6	0	Vendor ID
Bit 5	1	Vendor ID
Bit 4	X	Revision ID
Bit 3	X	Revision ID
Bit 2	X	Revision ID
Bit 1	X	Revision ID
Bit 0	X	Revision ID

Byte 9: Watchdog Timer Count Register

Bit	PWD	Description
Bit 7	0	
Bit 6	0	The decimal representation of these
Bit 5	0	8 bits correspond to 290ms or 1ms
Bit 4	1	the watchdog timer will wait before it goes to alarm mode and reset the
Bit 3	0	frequency to the safe setting. Default
Bit 2	0	at power up is 16X 290ms = 4.6
Bit 1	0	seconds.
Bit 0	0	

Byte 11: VCO Frequency Control Register

Bit	PWD	Description
Bit 7	X	VCO Divider Bit0
Bit 6	X	REF Divider Bit6
Bit 5	X	REF Divider Bit5
Bit 4	X	REF Divider Bit4
Bit 3	X	REF Divider Bit3
Bit 2	X	REF Divider Bit2
Bit 1	X	REF Divider Bit1
Bit 0	X	REF Divider Bit0

Note: The decimal representation of these 7 bits (Byte 11 [6:0]) + 2 is equal to the REF divider value .

Notes

1. PWD = Power on Default

Byte 8: Byte Count and Read Back Register

Bit	PWD	Description
Bit 7	0	Reserved
Bit 6	0	Reserved
Bit 5	0	Reserved
Bit 4	0	Reserved
Bit 3	1	Reserved
Bit 2	0	Reserved
Bit 1	0	Reserved
Bit 0	0	Reserved

Byte 10: VCO Control Selection Bit & Watchdog Timer Control Register

Bit	PWD	Description
Bit 7	0	0=Hw/B0 freq / 1=B11&12 freq
Bit 6	0	WD Enable 0=disable / 1=enable
Bit 5	0	WD Status 0=normal / 1=alarm
Bit 4	1	WD Safe Frequency, FS4
Bit 3	1	WD Safe Frequency, FS3
Bit 2	0	WD Safe Frequency, FS2
Bit 1	0	WD Safe Frequency, FS1
Bit 0	0	WD Safe Frequency, FS0

Note: FS values in bit (4:0) will correspond to Byte 0 FS values. Default safe frequency is same as 00000 entry in byte0.

Byte 12: VCO Frequency Control Register

Bit	PWD	Description
Bit 7	X	VCO Divider Bit8
Bit 6	X	VCO Divider Bit7
Bit 5	X	VCO Divider Bit6
Bit 4	X	VCO Divider Bit5
Bit 3	X	VCO Divider Bit4
Bit 2	X	VCO Divider Bit3
Bit 1	X	VCO Divider Bit2
Bit 0	X	VCO Divider Bit1

Note: The decimal representation of these 9 bits (Byte 12 bit [7:0] & Byte 11 bit [7]) + 8 is equal to the VCO divider value. For example if VCO divider value of 36 is desired, user need to program 36 - 8 = 28, namely, 0, 00011100 into byte 12 bit & byte 11 bit 7.



Byte 13: Spread Sectrum Control Register

Bit	PWD	Description
Bit 7	X	Spread Spectrum Bit7
Bit 6	X	Spread Spectrum Bit6
Bit 5	X	Spread Spectrum Bit5
Bit 4	X	Spread Spectrum Bit4
Bit 3	X	Spread Spectrum Bit3
Bit 2	X	Spread Spectrum Bit2
Bit 1	X	Spread Spectrum Bit1
Bit 0	X	Spread Spectrum Bit0

Note: Please utilize software utility provided by ICS Application Engineering to configure spread spectrum. Incorrect spread percentage may cause system failure.

Byte 15: Output Skew Control

Bit	PWD	Description
Bit 7	0	
Bit 6	1	PCICLKO Skew Control
Bit 5	1	FCICLRO Skew Collifor
Bit 4	0	
Bit 3	0	
Bit 2	1	DCICLY (6.1) Skow Control
Bit 1	1	PCICLK (6:1) Skew Control
Bit 0	0	

Byte 17: Output Rise/Fall Time Select Register

Bit	PWD	Description
Bit 7	1	CPUCLK_CS Slew Rate Control
Bit 6	0	CFUCLK_CS Siew Rate Collifor
Bit 5	1	CPUCLK0 Slew Rate Control
Bit 4	0	CPUCLKO Siew Rate Control
Bit 3	1	SDRAM0 Slew Rate Control
Bit 2	0	SDRAMO Siew Rate Collifor
Bit 1	1	SDDAM (12.1) Slavy Data Control
Bit 0	0	SDRAM (12:1) Slew Rate Control

Notes: 1. PWD = Power on Default

Byte 14: Spread Sectrum Control Register

Bit	PWD	Description
Bit 7	X	Reserved
Bit 6	X	Reserved
Bit 5	X	Reserved
Bit 4	X	Spread Spectrum Bit12
Bit 3	X	Spread Spectrum Bit11
Bit 2	X	Spread Spectrum Bit10
Bit 1	X	Spread Spectrum Bi 9
Bit 0	X	Spread Spectrum Bit8

Note: Please utilize software utility provided by ICS Application Engineering to configure spread spectrum. Incorrect spread percentage may cause system failure.

Byte 16: Output Skew Control

Bit	PWD	Description
Bit 7	0	SDRAM (12:1) Skew Control
Bit 6	0	SDRAWI (12.1) Skew Collifor
Bit 5	0	CPUCLK_CS Skew Control
Bit 4	0	CFUCLK_CS Skew Collifor
Bit 3	0	CPUCLKO Skew Control
Bit 2	0	Crocko Skew Collifor
Bit 1	0	SDRAM0 Skew Control
Bit 0	0	SDRAMO Skew Collidor

Byte 18: Output Rise/Fall Time Select Register

Bit	PWD	Description
Bit 7	1	PCICLK (6:1) Slew Rate Control
Bit 6	0	FCICLK (0.1) Siew Rate Collifor
Bit 5	1	PCICLK0 Slew Rate Control
Bit 4	0	FCICLEO Siew Rate Collifor
Bit 3	1	48MHz Slew Rate Control
Bit 2	0	46WHZ Siew Rate Control
Bit 1	1	24MHz Slew Rate Control
Bit 0	0	24WITZ Siew Rate Collifol

2. The power on default for byte 13-20 depends on the harware (latch inputs FS[0:4]) or I^2C (Byte 0 bit [1:7]) setting. Be sure to read back and re-write the values of these 8 registers when VCO frequency change is desired for the first



Byte 19: Reserved Register

Bit	PWD	Description
Bit 7	X	Reserved
Bit 6	X	Reserved
Bit 5	X	Reserved
Bit 4	X	Reserved
Bit 3	X	Reserved
Bit 2	X	Reserved
Bit 1	X	Reserved
Bit 0	X	Reserved

VCO Programming Constrains

 $VCO\,Frequency\,.....150MHz\,to\,500MHz$

VCO Divider Range 8 to 519 REF Divider Range 2 to 129

Phase Detector Stability 0.3536 to 1.4142

Useful Formula

VCO Frequency = 14.31818 x VCO/REF divider value Phase Detector Stabiliy = 14.038 x (VCO divider value)^{-0.5}

To program the VCO frequency for over-clocking.

- 0. Before trying to program our clock manually, consider using ICS provided software utilities for easy programming.
- 1. Select the frequency you want to over-clock from with the desire gear ratio (i.e. CPU:SDRAM:3V66:PCI ratio) by writing to byte 0, or using initial hardware power up frequency.
- 2. Write 0001, 1001 (19_H) to byte 8 for readback of 21 bytes (byte 0-20).
- 3. Read back byte 11-20 and copy values in these registers.
- 4. Re-initialize the write sequence.
- 5. Write a '1' to byte 9 bit 7 and write to byte 11 & 12 with the desired VCO & REF divider values.
- 6. Write to byte 13 to 20 with the values you copy from step 3. This maintains the output spread, skew and slew rate.
- 7. The above procedure is only needed when changing the VCO for the 1st pass. If VCO frequency needed to be changed again, user only needs to write to byte 11 and 12 unless the system is to reboot.

Note:

- 1. User needs to ensure step 3 & 7 is carried out. Systems with wrong spread percentage and/or group to group skew relation programmed into bytes 13-16 could be unstable. Step 3 & 7 assure the correct spread and skew relationship.
- 2. If VCO, REF divider values or phase detector stability are out of range, the device may fail to function correctly.
- 3. Follow min and max VCO frequency range provided. Internal PLL could be unstable if VCO frequency is too fast or too slow. Use 14.31818MHz x VCO/REF divider values to calculate the VCO frequency (MHz).
- 4. ICS recommends users, to utilize the software utility provided by ICS Application Engineering to program the VCO frequency.
- 5. Spread percent needs to be calculated based on VCO frequency, spread modulation frequency and spread amount desired. See Application note for software support.

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Byte 20: Reserved Register

Bit	PWD	Description
Bit 7	X	Reserved
Bit 6	X	Reserved
Bit 5	X	Reserved
Bit 4	X	Reserved
Bit 3	X	Reserved
Bit 2	X	Reserved
Bit 1	X	Reserved
Bit 0	X	Reserved

Note: Byte 19 and 20 are reserved registers, these are unused registers writing to these registers will not affect device performance or functionality.



Absolute Maximum Ratings

Supply Voltage..... 7.0 V

Logic Inputs GND -0.5 V to V_{DD} +0.5 V

Ambient Operating Temperature 0°C to +70°C

Storage Temperature -65°C to +150°C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Electrical Characteristics - Input/Supply/Common Output Parameters

 $T_A = 0 - 70$ °C; Supply Voltage V_{DD} , $V_{DDL} = 3.3 \text{ V +/-5}\%$ (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input High Voltage	V_{IH}		2		$V_{DD} + 0.3$	V
Input Low Voltage	V_{IL}		V _{SS} - 0.3		0.8	V
Input High Current	I _{IH}	$V_{IN} = V_{DD}$			5	mA
Input Low Current	I _{IL1}	V _{IN} = 0 V; Inputs with no pull-up resistors	-5			mA
Input Low Current	I _{IL2}	$V_{IN} = 0 \text{ V}$; Inputs with no pull-up resistors	-200			mA
Operating	I _{DD3.3OP66}	C _L = 0 pF; Select @ 66MHz		90	180	mA
Supply Current	I _{DD3.3OP100}	C _L = 0 pF; Select @ 100MHz		90	160	IIIA
Input frequency	Fi	$V_{DD} = 3.3 \text{ V}$	12		16	MHz
Input Capacitance ¹	C _{IN}	Logic Inputs			5	pF
	C_{INX}	X1 & X2 pins	27		45	pF
Clk Stabilization1	T _{STAB}	From $V_{DD} = 3.3 \text{ V}$ to 1% target Freq.			3	ms

¹Guaranteed by design, not 100% tested in production.

Electrical Characteristics - Input/Supply/Common Output Parameters

 $T_A = 0 - 70$ °C; Supply Voltage $V_{DD} = 3.3 \text{ V} + /-5\%$, $V_{DDL} = 2.5 \text{ V} + /-5\%$ (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating	I _{DD2.5OP66}	C _L = 0 pF; Select @ 66.8 MHz		10	72	mΛ
Supply Current	I _{DD2.5OP100}	C _L = 0 pF; Select @ 100 MHz		15	100	mA
Skew ¹	t _{CPU-PCI}	$V_T = 1.5 \text{ V}; \text{ VTL} = 1.25 \text{ V}$	1.5		4	ns

¹Guaranteed by design, not 100% tested in production.



Electrical Characteristics - CPUCLK

 $T_A = 0 - 70$ °C; $V_{DD} = 3.3 \text{ V +/-5\%}$, $V_{DDL} = 2.5 \text{ V +/-5\%}$; $C_L = 20 \text{ pF}$ (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	V_{OH2B}	I _{OH} = -12.0mA	2			V
Output Low Voltage	V_{OL2B}	I _{OL} = 12 mA			0.4	V
Output High Current	I _{OH2B}	$V_{OH} = 1.7 \text{ V}$			-19	mA
Output Low Current	I _{OL2B}	$V_{OL} = 0.7 \text{ V}$	19			mA
Rise Time	t _{r2B} ¹	$V_{OL} = 0.5V, V_{OH} = 2.0 V$		0.95	1.3	ns
Fall Time	t _{f2B} ¹	$V_{OH} = 2.0V, V_{OL} = 0.5 V$		0.95	1.3	ns
Duty Cycle	d _{t2B} ¹	$V_T = 1.25 \text{ V}$	45	49	55	%
Skew	t _{sk2B} ¹	$V_T = 1.25 \text{ V}$		145	175	ps
Jitter, Cycle-to-cycle	t _{jcyc-cyc2B} ¹	V _T = 1.25 V		225	250	ps

¹Guaranteed by design, not 100% tested in production.

Electrical Characteristics - PCICLK

 $T_A = 0 - 70$ °C; $V_{DD} = 3.3 \text{ V +/-5\%}$, $V_{DDL} = 2.5 \text{ V +/-5\%}$; $C_L = 30 \text{ pF}$ (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	V_{OH1}	I _{OH} = -11 mA	2.4			V
Output Low Voltage	V_{OL1}	$I_{OL} = 9.4 \text{ mA}$			0.4	V
Output High Current	I _{OH1}	$V_{OH} = 2.0 \text{ V}$			-22	mA
Output Low Current	I _{OL1}	$V_{OL} = 0.8 \text{ V}$	25			mA
Rise Time ¹	t _{r1}	$V_{OL} = 0.4 \text{ V}, V_{OH} = 2.4 \text{ V}$		1.6	2	ns
Fall Time ¹	t _{f1}	$V_{OH} = 2.4 \text{ V}, V_{OL} = 0.4 \text{ V}$		1.9	2	ns
Duty Cycle ¹	d _{t1}	V _T = 1.5 V	45	52	55	%
Skew ¹	t _{sk1}	V _T = 1.5 V		50	500	ps
Jitter, Cycle-to-cycle	t _{jcyc-cyc2B} ¹	V _T = 1.5 V		240	250	ps

¹Guaranteed by design, not 100% tested in production.



Electrical Characteristics - SDRAM

 $T_A = 0 - 70$ °C; $V_{DD} = 3.3 \text{ V +/-5\%}$, $V_{DDL} = 2.5 \text{ V +/-5\%}$; $C_L = 30 \text{ pF}$ (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	V_{OH3}	I _{OH} = -28mA	2.4			V
Output Low Voltage	V_{OL3}	$I_{OL} = 23 \text{ mA}$			0.4	V
Output High Current	I _{OH3}	$V_{OH} = 2.0 \text{ V}$			-54	mA
Output Low Current	I _{OL3}	$V_{OH} = 0.8 \text{ V}$	41			mA
Rise Time	T _{r31}	$V_{OL} = 0.4V, V_{OH} = 2.4 V$		0.85	2	ns
Fall Time	T _{f31}	$V_{OH} = 2.4V, V_{OL} = 0.4 V$		0.85	2	ns
Duty Cycle	D _{t31}	V _T = 1.5 V	45	50	55	%
Skew1	T _{sk1}	V _T = 1.5 V		200	500	ps
Propagation Delay	T_{prop}	V _T = 1.5 V			5	ns

¹Guarenteed by design, not 100% tested in production.

Electrical Characteristics - 24MHz, 48MHz, REF

 $T_{\text{A}} = 0 - 70^{\circ}\text{C}; \ V_{\text{DD}} = 3.3 \ \text{V} \ \text{+/-5\%}, \ V_{\text{DDL}} = 2.5 \ \text{V} \ \text{+/-5\%}; \ C_{\text{L}} = 20 \ \text{pF} \ \text{(unless otherwise stated)}$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output High Voltage	V_{OH5}	$I_{OH} = -16 \text{ mA}$	2.4			V
Output Low Voltage	V_{OL5}	$I_{OL} = 9 \text{ mA}$			0.4	V
Output High Current	I _{OH5}	$V_{OH} = 2.0 \text{ V}$			-22	mA
Output Low Current	I _{OL5}	$V_{OL} = 0.8 \text{ V}$	16			mA
Rise Time ¹		$V_{OL} = 0.4 \text{ V}, \text{ VOH} = 2.4 \text{ V}$		1.5	4	ns
Fall Time ¹	t _{f5}	$V_{OH} = 2.4 \text{ V}, \text{ VOL} = 0.4 \text{ V}$		1.5	4	ns
Duty Cycle ¹	d_{t5}	$V_T = 1.5 \text{ V}$	45	53	55	%
Jiter, Cycle-to-cycle (24, 48MHz)	t _{jcyc-cyc2B} 1	$V_T = 1.5 \text{ V}$		250	500	ps

¹Guaranteed by design, not 100% tested in production.



Shared Pin Operation - Input/Output Pins

The I/O pins designated by (input/output) serve as dual signal functions to the device. During initial power-up, they act as input pins. The logic level (voltage) that is present on these pins at this time is read and stored into a 5-bit internal data latch. At the end of Power-On reset, (see AC characteristics for timing values), the device changes the mode of operations for these pins to an output function. In this mode the pins produce the specified buffered clocks to external loads.

To program (load) the internal configuration register for these pins, a resistor is connected to either the VDD (logic 1) power supply or the GND (logic 0) voltage potential. A 10 Kilohm (10K) resistor is used to provide both the solid CMOS programming voltage needed during the power-up programming period and to provide an insignificant load on the output clock during the subsequent operating period.

Figure 1 shows a means of implementing this function when a switch or 2 pin header is used. With no jumper is installed the pin will be pulled high. With the jumper in place the pin will be pulled low. If programmability is not necessary, than only a single resistor is necessary. The programming resistors should be located close to the series termination resistor to minimize the current loop area. It is more important to locate the series termination resistor close to the driver than the programming resistor.

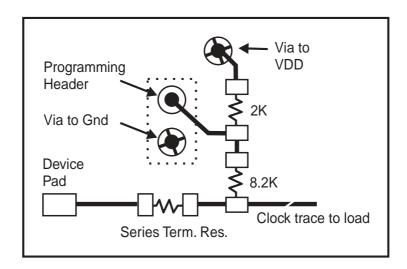
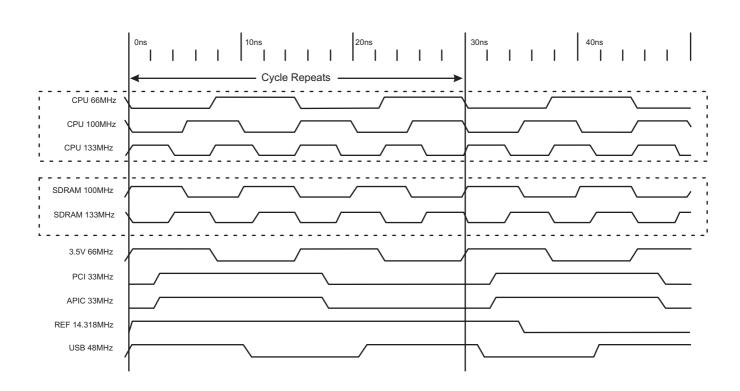


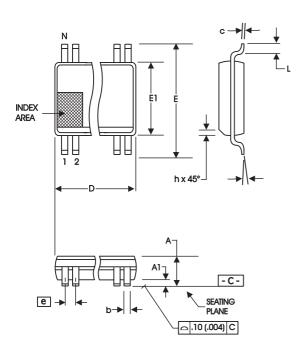
Fig. 1





Group Offset Waveforms





300 mil SSOP Package

	In Millir	meters	In Inches		
SYMBOL	COMMON D	IMENSIONS	COMMON DIMENSIONS		
	MIN	MAX	MIN	MAX	
Α	2.41	2.80	.095	.110	
A1	0.20	0.40	.008	.016	
b	0.20	0.34	.008	.0135	
С	0.13	0.25	.005	.010	
D	SEE VAR	IATIONS	SEE VARIATIONS		
E	10.03	10.68	.395	.420	
E1	7.40	7.60	.291	.299	
е	0.635 I	BASIC	0.025	BASIC	
h	0.38	0.64	.015	.025	
L	0.50	1.02	.020	.040	
N	SEE VARIATIONS SEE VARIATION		RIATIONS		
α	0°	8°	0°	8°	

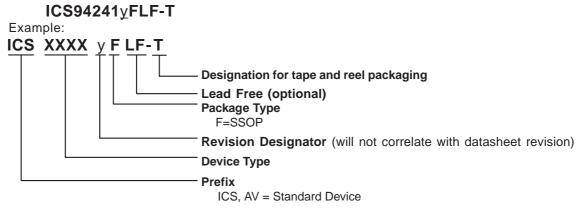
VARIATIONS

NI	Dm	nm.	D (inch)		
N	MIN	MAX	MIN	MAX	
48	15.75	16.00	.620	.630	

Reference Doc.: JEDEC Publication 95, MO-118

10-0034

Ordering Information



0453C-10/26/04



Revision History

Rev.	Issue Date	Description	Page #
С	10/26/2004	Added Lead Free Ordering Information	15